



vorläufige Daten
preliminary data

Höchstzulässige Werte / Maximum rated values

Elektrische Eigenschaften / Electrical properties

Kollektor-Emitter-Sperrspannung collector-emitter voltage		V_{CES}	1200	V
Kollektor-Dauergleichstrom DC-collector current	$T_C = 80^\circ\text{C}$ $T_C = 25^\circ\text{C}$	$I_{C,nom.}$ I_C	35 75	A A
Periodischer Kollektor Spitzenstrom repetitive peak collector current	$t_p = 1\text{ ms}$, $T_C = 80^\circ\text{C}$	I_{CRM}	70	A
Gesamt-Verlustleistung total power dissipation	$T_C = 25^\circ\text{C}$, Transistor	P_{tot}	310	W
Gate-Emitter-Spitzenspannung gate-emitter peak voltage		V_{GES}	+/- 20V	V
Dauergleichstrom DC forward current		I_F	35	A
Periodischer Spitzenstrom repetitive peak forw. current	$t_p = 1\text{ ms}$	I_{FRM}	70	A
Grenzlastintegral der Diode I^2t - value, Diode	$V_R = 0\text{V}$, $t_p = 10\text{ms}$, $T_{vj} = 125^\circ\text{C}$	I^2t	400	A^2s
Isolations-Prüfspannung insulation test voltage	RMS, $f = 50\text{ Hz}$, $t = 1\text{ min.}$	V_{ISOL}	2,5	kV

Charakteristische Werte / Characteristic values

Transistor / Transistor

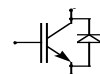
			min.	typ.	max.	
Kollektor-Emitter Sättigungsspannung collector-emitter saturation voltage	$I_C = 35\text{A}$, $V_{GE} = 15\text{V}$, $T_{vj} = 25^\circ\text{C}$ $I_C = 35\text{A}$, $V_{GE} = 15\text{V}$, $T_{vj} = 125^\circ\text{C}$	$V_{CE\text{ sat}}$	- -	2,1 2,4	2,6	V V
Gate-Schwellenspannung gate threshold voltage	$I_C = 1,2\text{mA}$, $V_{CE} = V_{GE}$, $T_{vj} = 25^\circ\text{C}$	$V_{GE(th)}$	4,5	5,5	6,5	V
Gateladung gate charge	$V_{GE} = -15\text{V} \dots +15\text{V}$	Q_G	-	0,35	-	μC
Eingangskapazität input capacitance	$f = 1\text{MHz}$, $T_{vj} = 25^\circ\text{C}$, $V_{CE} = 25\text{V}$, $V_{GE} = 0\text{V}$	C_{ies}	-	2	-	nF
Rückwirkungskapazität reverse transfer capacitance	$f = 1\text{MHz}$, $T_{vj} = 25^\circ\text{C}$, $V_{CE} = 25\text{V}$, $V_{GE} = 0\text{V}$	C_{res}	-	t.b.d.	-	nF
Kollektor-Emitter Reststrom collector-emitter cut-off current	$V_{CE} = 1200\text{V}$, $V_{GE} = 0\text{V}$, $T_{vj} = 25^\circ\text{C}$ $V_{CE} = 1200\text{V}$, $V_{GE} = 0\text{V}$, $T_{vj} = 125^\circ\text{C}$	I_{CES}	- -	5 250	500	μA μA
Gate-Emitter Reststrom gate-emitter leakage current	$V_{CE} = 0\text{V}$, $V_{GE} = 20\text{V}$, $T_{vj} = 25^\circ\text{C}$	I_{GES}	-	-	400	nA

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Charakteristische Werte / Characteristic values

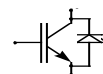
Transistor / Transistor

			min.	typ.	max.	
Einschaltverzögerungszeit (ind. Last) turn on delay time (inductive load)	$I_C = 35A, V_{CE} = 600V$	$t_{d,on}$	-	0,05	-	μs
	$V_{GE} = \pm 15V, R_G = 22\Omega, T_{vj} = 25^\circ C$					
	$V_{GE} = \pm 15V, R_G = 22\Omega, T_{vj} = 125^\circ C$					
Anstiegszeit (induktive Last) rise time (inductive load)	$I_C = 35A, V_{CE} = 600V$	t_r	-	0,05	-	μs
	$V_{GE} = \pm 15V, R_G = 22\Omega, T_{vj} = 25^\circ C$					
	$V_{GE} = \pm 15V, R_G = 22\Omega, T_{vj} = 125^\circ C$					
Abschaltverzögerungszeit (ind. Last) turn off delay time (inductive load)	$I_C = 35A, V_{CE} = 600V$	$t_{d,off}$	-	0,25	-	μs
	$V_{GE} = \pm 15V, R_G = 22\Omega, T_{vj} = 25^\circ C$					
	$V_{GE} = \pm 15V, R_G = 22\Omega, T_{vj} = 125^\circ C$					
Fallzeit (induktive Last) fall time (inductive load)	$I_C = 35A, V_{CE} = 600V$	t_f	-	0,03	-	μs
	$V_{GE} = \pm 15V, R_G = 22\Omega, T_{vj} = 25^\circ C$					
	$V_{GE} = \pm 15V, R_G = 22\Omega, T_{vj} = 125^\circ C$					
Einschaltverlustenergie pro Puls turn-on energy loss per pulse	$I_C = 35A, V_{CE} = 600V, V_{GE} = 15V$	E_{on}	-	4,5	-	mWs
	$R_G = 22\Omega, T_{vj} = 125^\circ C, L_S = 120nH$					
Abschaltverlustenergie pro Puls turn-off energy loss per pulse	$I_C = 35A, V_{CE} = 600V, V_{GE} = 15V$	E_{off}	-	4,3	-	mWs
	$R_G = 22\Omega, T_{vj} = 125^\circ C, L_S = 120nH$					
Kurzschlußverhalten SC Data	$t_p \leq 10\mu sec, V_{GE} \leq 15V, R_G = 22\Omega$	I_{SC}	-	320	-	A
	$T_{vj} \leq 125^\circ C, V_{CC} = 900V, V_{CEmax} = V_{CES} - L_{sCE} \cdot di/dt$					
Modulinduktivität stray inductance module		L_{sCE}	-	40	-	nH
Modul Leitungswiderstand, Anschlüsse – Chip module lead resistance, terminals – chip	$T_C = 25^\circ C$	R_{CC+EE}	-	1,2	-	m Ω

Charakteristische Werte / Characteristic values

Diode / Diode

			min.	typ.	max.	
Durchlaßspannung forward voltage	$I_F = 35A, V_{GE} = 0V, T_{vj} = 25^\circ C$	V_F	-	1,8	2,3	V
	$I_F = 35A, V_{GE} = 0V, T_{vj} = 125^\circ C$					
Rückstromspitze peak reverse recovery current	$I_F = 35A, -di_F/dt = 900A/\mu sec$	I_{RM}	-	36	-	A
	$V_R = 600V, V_{GE} = -15V, T_{vj} = 25^\circ C$					
	$V_R = 600V, V_{GE} = -15V, T_{vj} = 125^\circ C$					
Sperrverzögerungsladung recovered charge	$I_F = 35A, -di_F/dt = 900A/\mu sec$	Q_r	-	3,6	-	μAs
	$V_R = 600V, V_{GE} = -15V, T_{vj} = 25^\circ C$					
	$V_R = 600V, V_{GE} = -15V, T_{vj} = 125^\circ C$					
Abschaltenergie pro Puls reverse recovery energy	$I_F = 35A, -di_F/dt = 900A/\mu sec$	E_{rec}	-	1,3	-	mWs
	$V_R = 600V, V_{GE} = -15V, T_{vj} = 25^\circ C$					
	$V_R = 600V, V_{GE} = -15V, T_{vj} = 125^\circ C$					



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Thermische Eigenschaften / Thermal properties

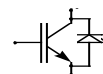
			min.	typ.	max.	
Innerer Wärmewiderstand thermal resistance, junction to case	Transistor / transistor, DC	R_{thJC}	-	-	0,4	K/W
	Diode/Diode, DC		-	-	0,7	K/W
Übergangs-Wärmewiderstand thermal resistance, case to heatsink	pro Modul / per module $\lambda_{flüssig} = 1 \text{ W/m} \cdot \text{K}$ / $\lambda_{grease} = 1 \text{ W/m} \cdot \text{K}$	R_{thCK}	-	0,05	-	K/W
Höchstzulässige Sperrschichttemperatur maximum junction temperature		T_{vj}	-	-	150	°C
Betriebstemperatur operation temperature		T_{op}	-40	-	125	°C
Lagertemperatur storage temperature		T_{stg}	-40	-	150	°C

Mechanische Eigenschaften / Mechanical properties

Gehäuse, siehe Anlage case, see appendix					
Innere Isolation internal insulation			AL ₂ O ₃		
Kriechstrecke creepage distance			20		mm
Luftstrecke clearance			11		mm
CTI comperative tracking index			275		
Anzugsdrehmoment f. mech. Befestigung mounting torque	terminals M6	M1	3	6	Nm
Anzugsdrehmoment f. elektr. Anschlüsse terminal connection torque	terminals M5	M2	2,5	5	Nm
Gewicht weight		G	250		g

Mit dieser technischen Information werden Halbleiterbauelemente spezifiziert, jedoch keine Eigenschaften zugesichert.
 Sie gilt in Verbindung mit den zugehörigen Technischen Erläuterungen.

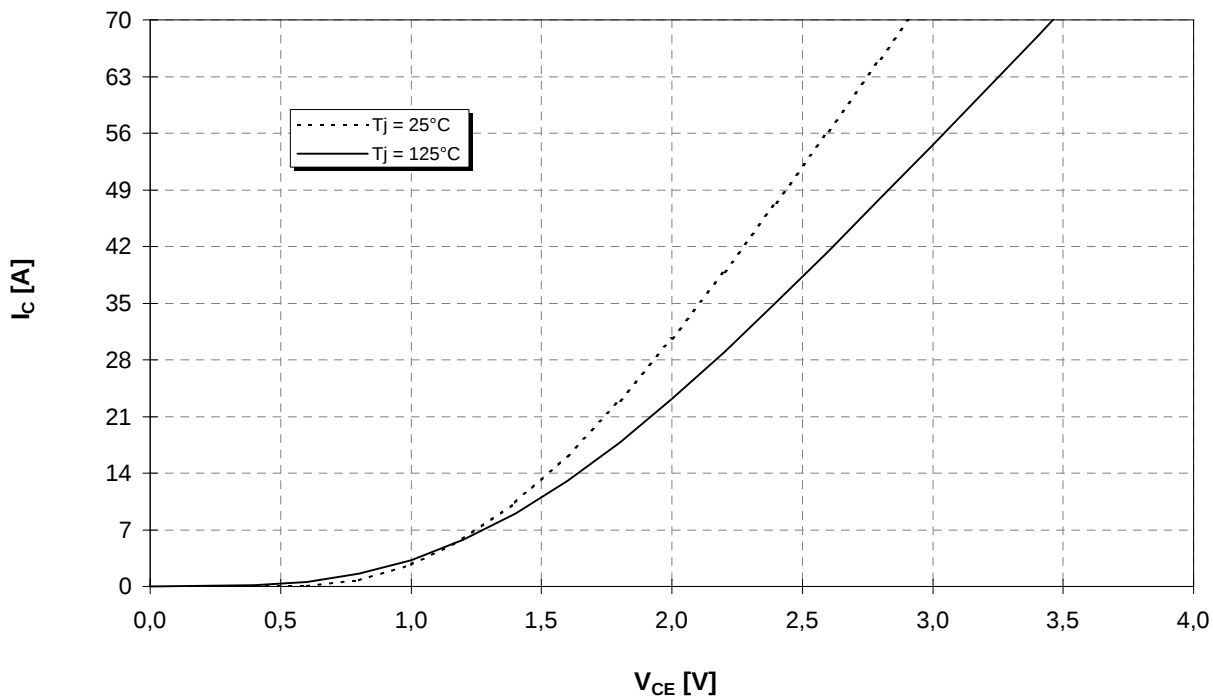
This technical information specifies semiconductor devices but promises no characteristics. It is
 valid in combination with the belonging technical notes.



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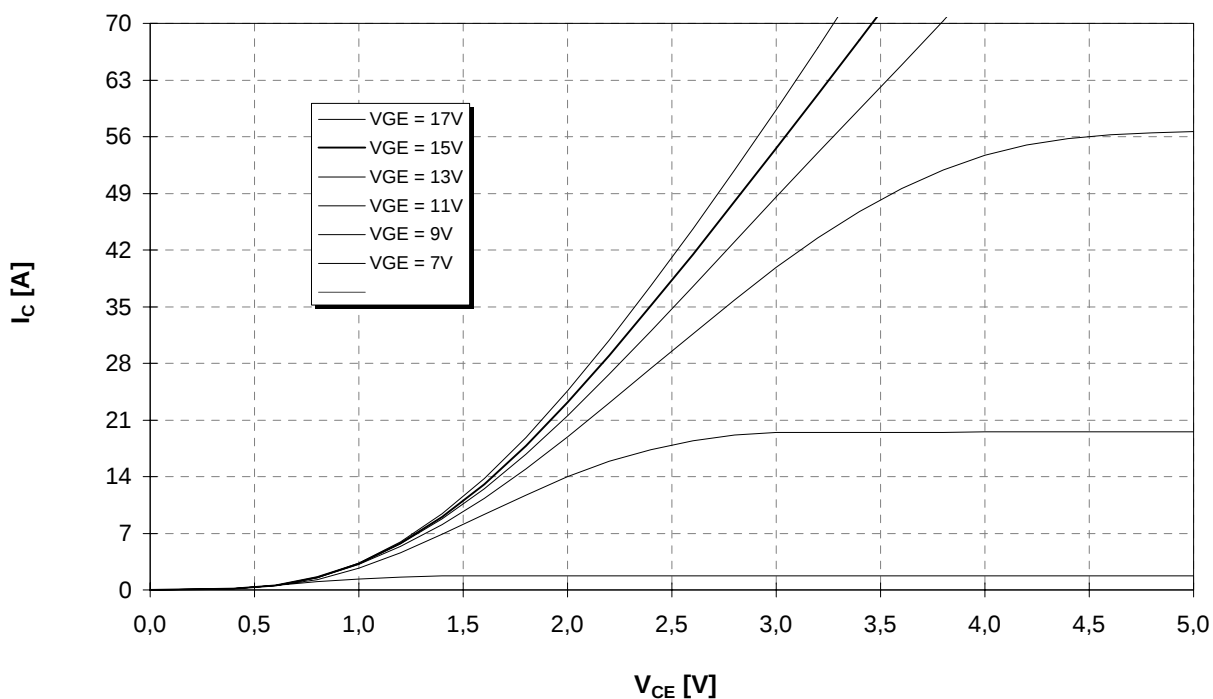
Ausgangskennlinie (typisch)
Output characteristic (typical)

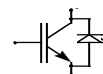
$I_c = f(V_{CE})$
 $V_{GE} = 15V$



Ausgangskennlinienfeld (typisch)
Output characteristic (typical)

$I_c = f(V_{CE})$
 $T_{vj} = 125^\circ C$



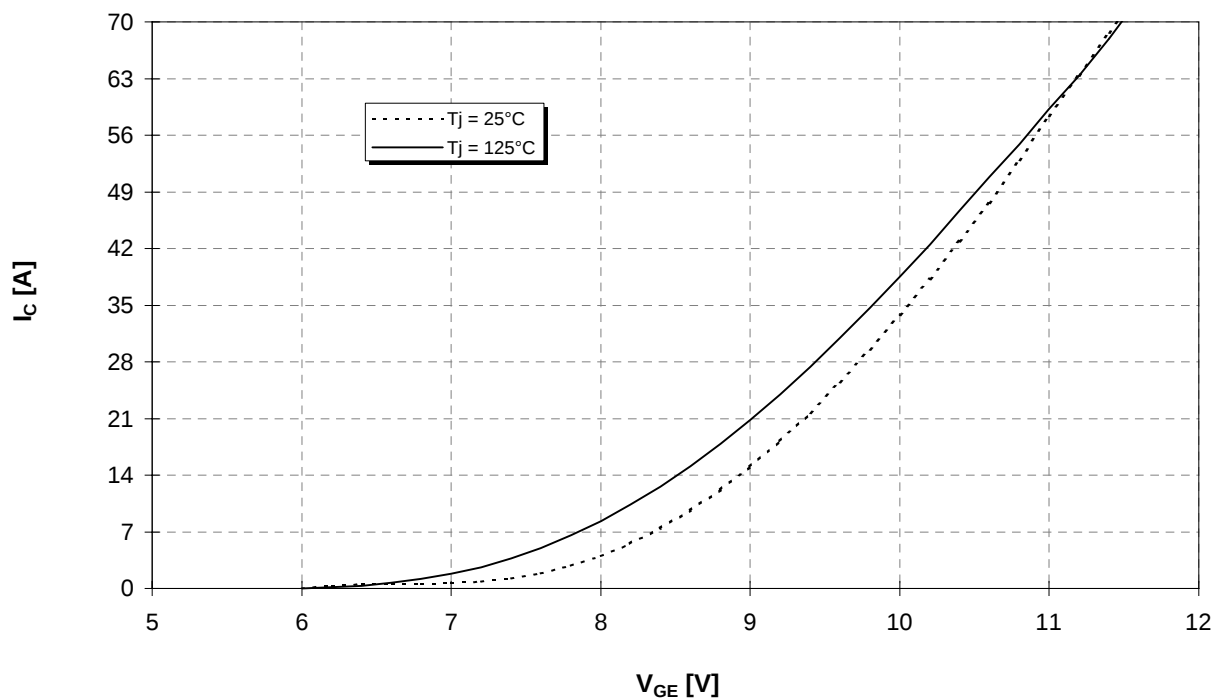


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Übertragungscharakteristik (typisch)
Transfer characteristic (typical)

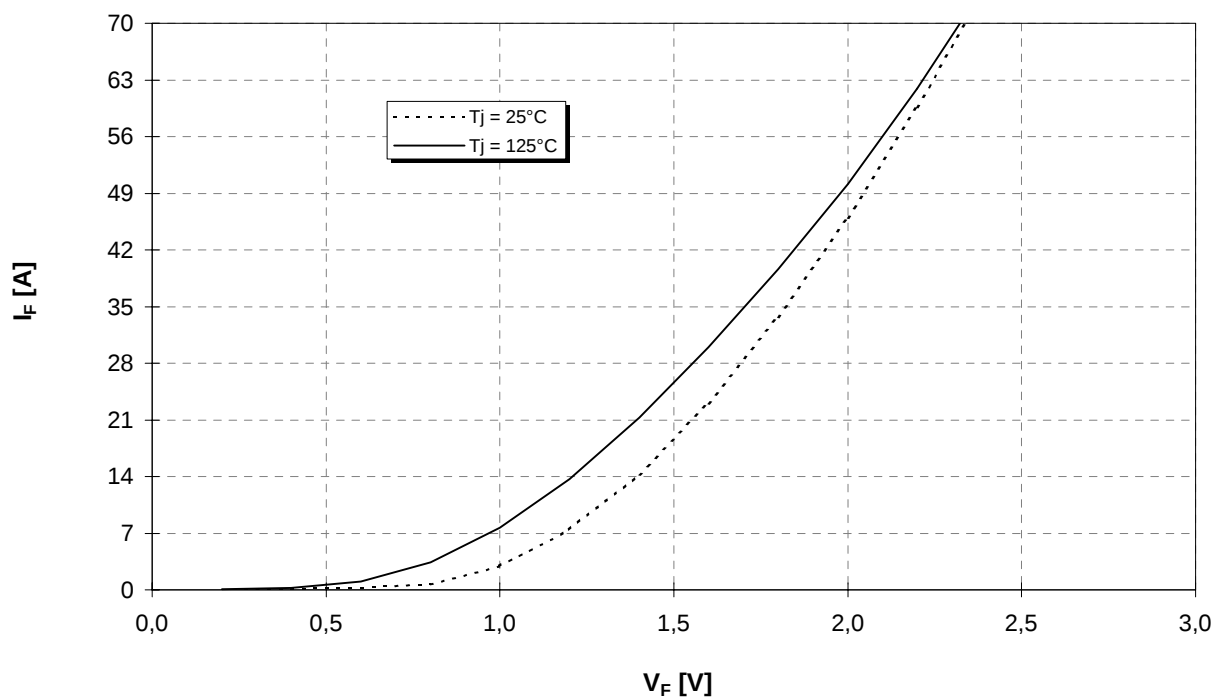
$$I_c = f(V_{GE})$$

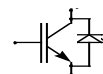
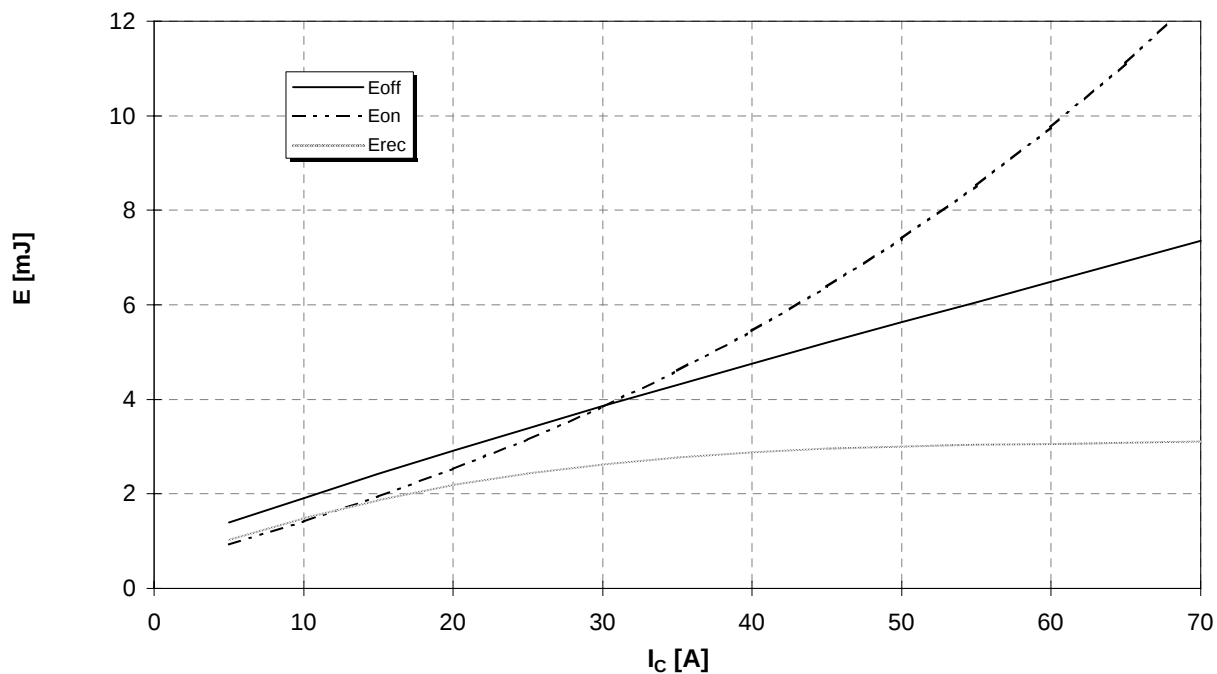
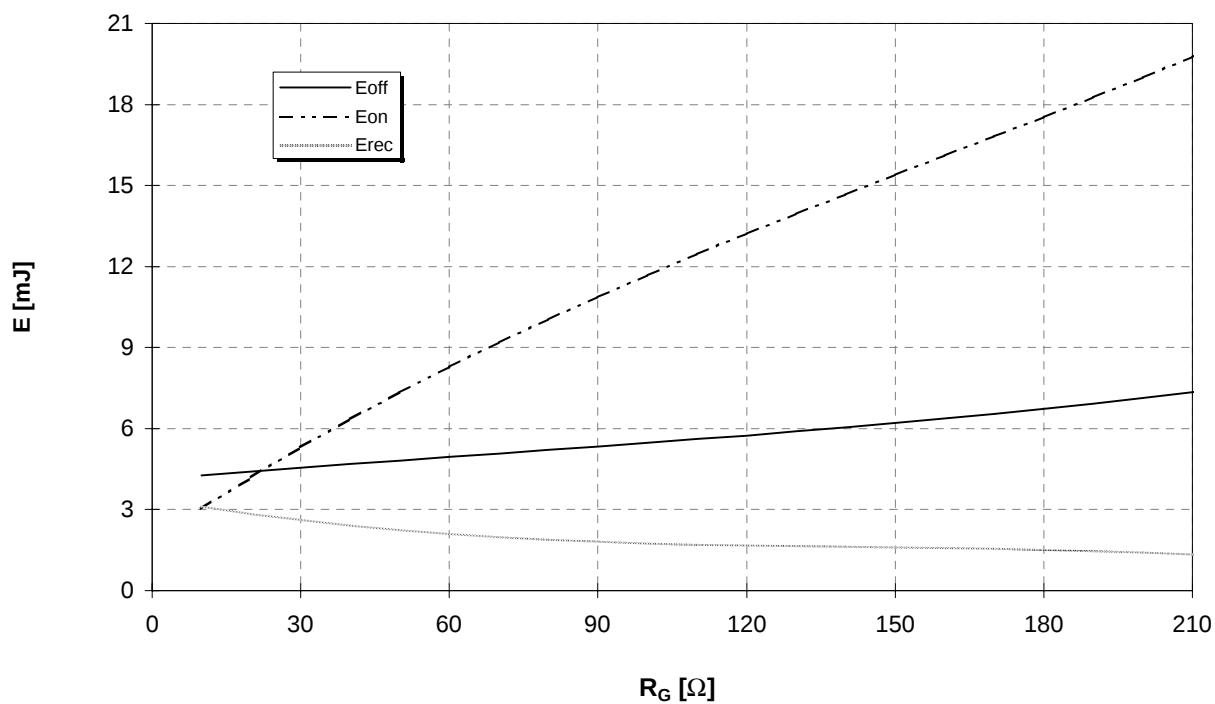
$V_{CE} = 20V$

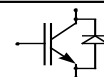


Durchlaßkennlinie der Inversdiode (typisch)
Forward characteristic of inverse diode (typical)

$$I_F = f(V_F)$$



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Switching losses (typical) $E_{on} = f(R_G)$, $E_{off} = f(R_G)$, $E_{rec} = f(R_G)$ $V_{GE}=15V$, $I_C = 35A$, $V_{CE} = 600V$, $T_J = 125^\circ C$ 

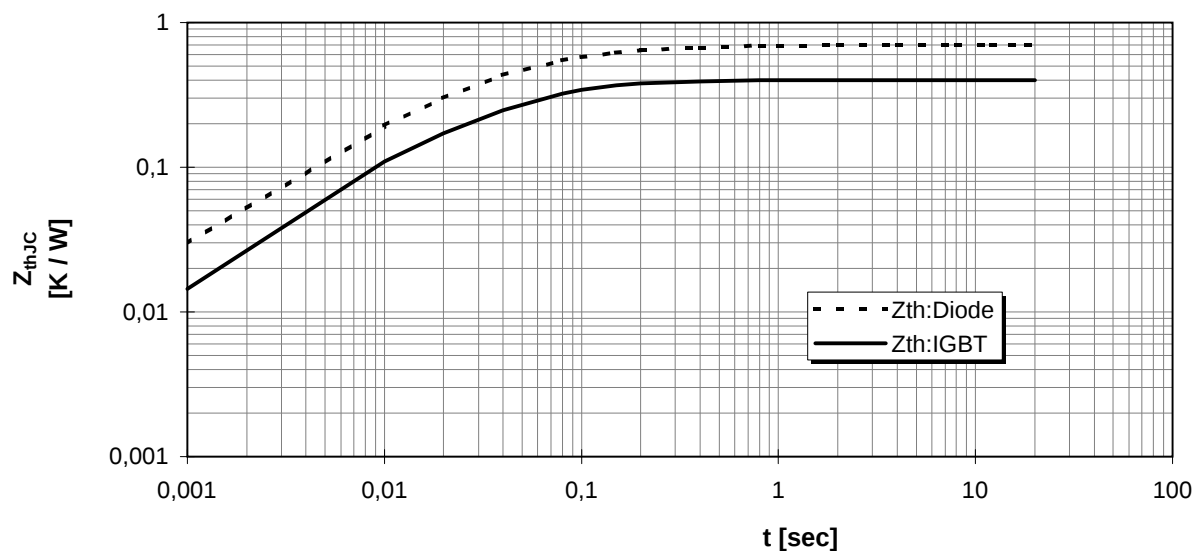


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Transienter Wärmewiderstand
Transient thermal impedance

$Z_{thJC} = f(t)$

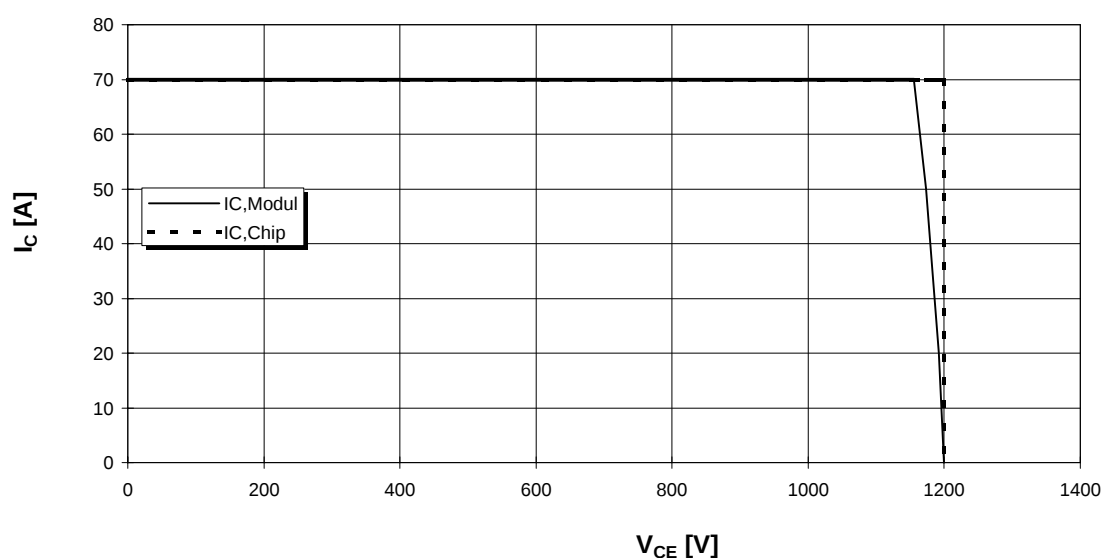


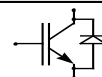
i	1	2	3	4
r_i [K/kW] : IGBT	78,07	262,83	20,86	38,24
τ_i [sec] : IGBT	0,009	0,045	0,073	0,229
r_i [K/kW] : Diode	41,47	305,3	271,51	81,72
τ_i [sec] : Diode	0,003	0,022	0,064	0,344

Sicherer Arbeitsbereich (RBSOA)

Reverse bias safe operation area (RBSOA)

$V_{GE} = 15V$, $R_g = 22 \text{ Ohm}$, $T_{vj} = 125^\circ C$





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